

SN74AHCT540

SN54AHCT540

SCLS268M-OCTOBER 1995-REVISED JUNE 2013

# **OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS**

Check for Samples: SN54AHCT540, SN74AHCT540

#### **FEATURES**

- Inputs Are TTL-Voltage Compatible
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### DESCRIPTION

The 'AHCT540 octal buffers/drivers are ideal for driving bus lines or buffer memory address registers. These devices feature inputs and outputs on opposite sides of the package to facilitate printed circuit board layout.

The 3-state control gate is a two-input AND gate with active-low inputs so that if either output-enable (OE1 or OE2) input is high, all corresponding outputs are in the high-impedance state. The outputs provide inverted data when they are not in the highimpedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

| SN54AHCT540 J OR W PACKAGE                    |
|---|
| SN74AHCT540 DB, DGV, DW, N, NS, OR PW PACKAGE |
| (TOP VIEW)                                    |

|     | (  | ••=••,          |                   |
|-----|----|-----------------|-------------------|
| OE1 |    | J <sub>20</sub> | ] v <sub>cc</sub> |
| A1  | 2  | 19              | ] OE2             |
| A2  | 3  | 18              | ] Y1              |
| A3  | 4  | 17              | ] Y2              |
| A4  |    | 16              | ] Y3              |
| A5  | 6  | 15              | ] Y4              |
| A6  | 7  | 14              | ] Y5              |
| A7  | 8  | 13              | ] Y6              |
| A8  | 9  | 12              | ] Y7              |
| GND | 10 | 11              | ] Y8              |
|     |    |                 |                   |

#### SN54AHCT540 ... FK PACKAGE (TOP VIEW)

|                            | A2<br>A1<br><u>0E1</u><br><u>0E2</u> |
|----------------------------|--------------------------------------|
|                            |                                      |
| A3<br>A4<br>A5<br>A6<br>A7 | 3 2 1 20 19<br>4 18 Y1<br>5 17 Y2    |
| A4                         | P' 9                                 |
| A5                         | 6 16 Y3                              |
| A6                         | ] 7 15 [ Y4                          |
| A7                         | 814 [ Y5                             |
|                            | <u>9 10 11 12 13</u>                 |
| 1                          |                                      |
|                            | A8<br>GND<br>Y8<br>Y7<br>Y6          |

|     | (EACH BUFFER/DRIVER) |   |   |  |  |  |  |  |  |  |  |
|-----|----------------------|---|---|--|--|--|--|--|--|--|--|
|     | INPUTS               |   |   |  |  |  |  |  |  |  |  |
| OE1 | OE1 OE2 A            |   |   |  |  |  |  |  |  |  |  |
| L   | L                    | L | Н |  |  |  |  |  |  |  |  |
| L   | L                    | Н | L |  |  |  |  |  |  |  |  |
| Н   | Х                    | Х | Z |  |  |  |  |  |  |  |  |
| Х   | н                    | Х | Z |  |  |  |  |  |  |  |  |

# **FUNCTION TABLE**

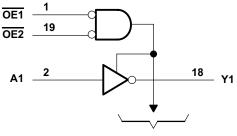


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TEXAS INSTRUMENTS

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#### LOGIC DIAGRAM (POSITIVE LOGIC)



**To Seven Other Channels** 

#### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|  |  | VALUE      | UNIT             |  |  |  |
|--|--|------------|------------------|--|--|--|
| Supply voltage range, V <sub>CC</sub>                                  |  | –0.5 to 7  | V                |  |  |  |
| Input voltage range, VI <sup>(2)</sup>                                 | Input voltage range, VI <sup>(2)</sup> |            |                  |  |  |  |
| Output voltage range, V <sub>O</sub> <sup>(2)</sup>                    | –0.5 to V <sub>CC</sub> + 0.5          | V          |                  |  |  |  |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)              | -20                                    | mA         |                  |  |  |  |
| Output clamp current, $I_{OK}$ (V <sub>O</sub> < 0 or V <sub>O</sub> > | ±20                                    | mA         |                  |  |  |  |
| Continuous output current, $I_O (V_O = 0 \text{ to } V$                | ±25                                    | mA         |                  |  |  |  |
| Continuous current through V <sub>CC</sub> or GND                      | ±75                                    | mA         |                  |  |  |  |
|  | DB package                             | 70         |                  |  |  |  |
|  | DGV package                            | 92         |                  |  |  |  |
| Declars the set of the set of $(3)$                                    | DW package                             | 58         | 0 <b>0</b> 0 0 0 |  |  |  |
| Package thermal impedance, $\theta_{JA}$ <sup>(3)</sup>                | N package                              | 69         | °C/W             |  |  |  |
|  | NS package                             | 60         |                  |  |  |  |
|  | PW package                             | 83         |                  |  |  |  |
| Storage temperature range, T <sub>stg</sub>                            |  | -65 to 150 | °C               |  |  |  |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The package thermal impedance is calculated in accordance with JESD 51-7.



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#### **RECOMMENDED OPERATING CONDITIONS**<sup>(1)</sup>

|                 |                                    | SN54AHCT540 |                 | SN74AHC | T540            | UNIT |
|-----------------|------------------------------------|-------------|-----------------|---------|-----------------|------|
|                 |                                    | MIN         | MAX             | MIN     | MAX             | UNIT |
| V <sub>CC</sub> | Supply voltage                     | 4.5         | 5.5             | 4.5     | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage           | 2           |                 | 2       |                 | V    |
| V <sub>IL</sub> | Low-level Input voltage            |             | 0.8             |         | 0.8             | V    |
| VI              | Input voltage                      | 0           | 5.5             | 0       | 5.5             | V    |
| Vo              | Output voltage                     | 0           | V <sub>CC</sub> | 0       | V <sub>CC</sub> | V    |
| I <sub>OH</sub> | High-level output current          |             | -8              |         | -8              | mA   |
| I <sub>OL</sub> | Low-level output current           |             | 8               |         | 8               | mA   |
| Δt/Δv           | Input Transition rise or fall rate |             | 20              |         | 20              | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     | -55         | 125             | -40     | 125             | °C   |

 All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

#### **ELECTRICAL CHARACTERISTICS**

over operating free-air temperature range (unless otherwise noted)

|                       |   |                 |      |                       |       | $T_{A} = -55^{\circ}$ |                   | $T_{A} = -40^{\circ}$ |       | T <sub>A</sub> = -40°<br>125°( |      |      |
|-----------------------|---|-----------------|------|-----------------------|-------|-----------------------|-------------------|-----------------------|-------|--------------------------------|------|------|
| PARAMETER             | TEST CONDITIONS                                     | Vcc             |      | T <sub>A</sub> = 25°0 | 5     | 125°C                 |                   | 85°C                  |       | Recommended                    |      | UNIT |
|                       |   |                 |      |                       |       | SN54AHCT540           |                   | SN74AH                | CT540 | SN74AHCT540                    |      |      |
|                       |   |                 | MIN  | TYP                   | MAX   | MIN                   | MAX               | MIN                   | MAX   | MIN                            | MAX  |      |
| N/                    | I <sub>OH</sub> = -50 μA                            | 451             | 4.4  | 4.5                   |       | 4.4                   |                   | 4.4                   |       | 4.4                            |      | v    |
| V <sub>OH</sub>       | I <sub>OH</sub> = -8 mA                             | 4.5 V           | 3.94 |                       |       | 3.8                   |                   | 3.8                   |       | 3.8                            |      | v    |
| \/                    | I <sub>OL</sub> = 50 μA                             | 4.5 V           |      |                       | 0.1   |                       | 0.1               |                       | 0.1   |                                | 0.1  | v    |
| V <sub>OL</sub>       | I <sub>OH</sub> = 8 mA                              | 4.5 V           |      |                       | 0.36  |                       | 0.44              |                       | 0.44  |                                | 0.44 |      |
| I <sub>I</sub>        | $V_1 = 5.5 V \text{ or GND}$                        | 0 V to 5.5<br>V |      |                       | ±0.1  |                       | ±1 <sup>(1)</sup> |                       | ±1    |                                | ±1   | μA   |
| I <sub>oz</sub>       | $V_0 = V_{CC}$ or GND                               | 5.5 V           |      |                       | ±0.25 |                       | ±2.5              |                       | ±2.5  |                                | ±2.5 | μA   |
| I <sub>CC</sub>       |   | 5.5 V           |      |                       | 4     |                       | 40                |                       | 20    |                                | 40   | μA   |
| $\Delta I_{CC}^{(2)}$ | One input at 3.4 V, Other inputs at $V_{CC}$ or GND | 5.5 V           |      |                       | 1.35  |                       | 1.5               |                       | 1.5   |                                | 1.5  | mA   |
| Ci                    | $V_I = V_{CC}$ or GND                               | 5 V             |      | 2                     | 10    |                       |                   |                       | 10    |                                |      | pF   |
| Co                    | $V_0 = V_{CC}$ or GND                               | 5V              |      | 4                     |       |                       |                   |                       |       |                                |      | pF   |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested at VCC = 0 V.

(2) This is the increase in supply current for each input at one of the specified TTL voltage levels, rather than 0 V or VCC.

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#### SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range,  $V_{CC} = 5 V \pm 0.5 V$  (unless otherwise noted) (see Figure 1)

|                    |         |          |                        |                        | T <sub>A</sub> = 25°C  |                  | 5°C TO             | T <sub>A</sub> = -4 |        | T <sub>A</sub> = -40°C TO<br>125°C |      |    |    |     |
|--------------------|---------|----------|------------------------|------------------------|------------------------|------------------|--------------------|---------------------|--------|------------------------------------|------|----|----|-----|
| PARAMETER          | FROM    | TO       | LOAD<br>CAPACITANCE    | T <sub>A</sub> = 2     |                        |                  | 125°C              |                     | C      | Recom                              | UNIT |    |    |     |
|                    | (INPUT) | (OUTPUT) |                        | ITANCE                 |                        | SN54AHCT540      |                    | SN54AH              | ICT540 | SN54AHCT540                        |      |    |    |     |
|                    |         |          |                        | TYP                    | MAX                    | MIN              | MAX                | MIN                 | MAX    | MIN                                | MAX  |    |    |     |
| t <sub>PLH</sub>   | •       | Y        | 0 45 -5                | 4.0 <sup>(1)</sup>     | 6.0 <sup>(1)</sup>     | 1 <sup>(1)</sup> | 7.5 <sup>(1)</sup> | 1                   | 7.5    | 1                                  | 7.5  |    |    |     |
| t <sub>PHL</sub>   | A       | Ŷ        | C <sub>L</sub> = 15 pF | 4.0 <sup>(1)</sup>     | 6.0 <sup>(1)</sup>     | 1 <sup>(1)</sup> | 7.5 <sup>(1)</sup> | 1                   | 7.5    | 1                                  | 7.5  | ns |    |     |
| t <sub>PZH</sub>   | OE      | Y        | 0 15 55                | 5.5 <sup>(1)</sup>     | 8.0 <sup>(1)</sup>     | 1 <sup>(1)</sup> | 9 <sup>(1)</sup>   | 1                   | 9.0    | 1                                  | 9.0  | 20 |    |     |
| t <sub>PZL</sub>   | OE      | Ŷ        | C <sub>L</sub> = 15 pF | 5.5 <sup>(1)</sup>     | 8.0 <sup>(1)</sup>     | 1 <sup>(1)</sup> | 9 <sup>(1)</sup>   | 1                   | 9.0    | 1                                  | 9.0  | ns |    |     |
| t <sub>PHZ</sub>   | OE      | Y        | 0 15 55                | 5.0 <sup>(1)</sup>     | 8.0 <sup>(1)</sup>     | 1 <sup>(1)</sup> | 9 <sup>(1)</sup>   | 1                   | 9      | 1                                  | 9    | 20 |    |     |
| t <sub>PLZ</sub>   | OE      | Ŷ        | C <sub>L</sub> = 15 pF | 5.0 <sup>(1)</sup>     | 8.0 <sup>(1)</sup>     | 1 <sup>(1)</sup> | 9 <sup>(1)</sup>   | 1                   | 9      | 1                                  | 9    | ns |    |     |
| t <sub>PLH</sub>   | А       | Y        |                        | 6.0                    | 8.5                    | 1                | 10                 | 1                   | 10     | 1                                  | 10   | 20 |    |     |
| t <sub>PHL</sub>   | A       | ř        | C <sub>L</sub> = 50 pF | 6.0                    | 8.5                    | 1                | 10                 | 1                   | 10     | 1                                  | 10   | ns |    |     |
| t <sub>PZH</sub>   | OE      | Y        | C <sub>1</sub> = 50 pF | 7.5                    | 11.0                   | 1                | 12                 | 1                   | 12     | 1                                  | 12   | 20 |    |     |
| t <sub>PZL</sub>   | 0E      | I        | $O_L = 50 \text{ pr}$  | 7.5                    | 11.0                   | 1                | 12                 | 1                   | 12     | 1                                  | 12   | ns |    |     |
| t <sub>PHZ</sub>   | OE      | Y        | C = 50  pF             | 8.0                    | 11.0                   | 1                | 12                 | 1                   | 12     | 1                                  | 12   | ns |    |     |
| t <sub>PLZ</sub>   | UE      | Ť        | C <sub>L</sub> = 50 pF | С <sub>L</sub> = 50 рн | C <sub>L</sub> = 50 pF | 8.0              | 11.0               | 1                   | 12     | 1                                  | 12   | 1  | 12 | 115 |
| t <sub>sk(o)</sub> |         |          | C <sub>L</sub> = 50 pF |                        | 1 <sup>(2)</sup>       |                  |                    |                     | 1      |                                    |      |    |    |     |

On products compliant to MIL-PRF-38535, this parameter is not production tested.
 On products compliant to MIL-PRF-38535, this parameter does not apply

#### **OPERATING CHARACTERISTICS**

 $V_{CC} = 5 \text{ V}, \text{ } T_{A} = 25^{\circ}\text{C}$ 

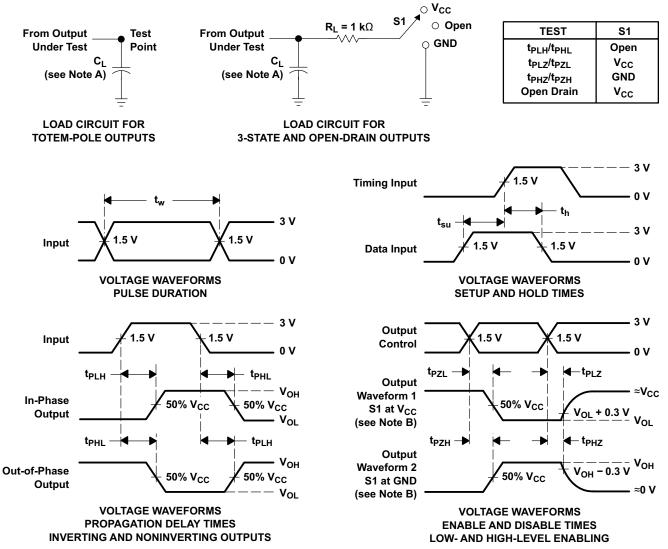
|                 | PARAMETER                     | TEST C   | CONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|----------|------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | No load, | f = 1 MHz  | 12  | pF   |

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#### PARAMETER MEASUREMENT INFORMATION



- A. C<sub>L</sub> includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

- C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz,  $Z_0 = 50 \Omega$ ,  $t_r \le 3 \text{ ns}$ ,  $t_f \le 3 \text{ ns}$ .
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuit and Voltage Waveforms

### **REVISION HISTORY**

| Changes from Revision L (July 2003) to Revision M       Page         • Changed document format from Quicksilver to DocZone.       • |  | ge  |
|---|--|-----|
| •   | Changed document format from Quicksilver to DocZone. | . 1 |
| •   | Extended operating temperature range to 125°C        | . 3 |

6



#### PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)              | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|-------------------------------|----------------------|--------------|--------------------------------------|---------|
|                  |               |              |                    |      |                |                     | (6)                           |                      |              |                                      |         |
| 5962-9685101QRA  | ACTIVE        | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type   | -55 to 125   | 5962-9685101QR<br>A                  | Samples |
|                  |               |              |                    |      |                |                     |                               |                      |              | SNJ54AHCT540J                        |         |
| SN74AHCT540DBR   | ACTIVE        | SSOP         | DB                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | HB540                                | Samples |
| SN74AHCT540DGVR  | ACTIVE        | TVSOP        | DGV                | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | HB540                                | Samples |
| SN74AHCT540DW    | ACTIVE        | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AHCT540                              | Samples |
| SN74AHCT540DWR   | ACTIVE        | SOIC         | DW                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AHCT540                              | Samples |
| SN74AHCT540DWRE4 | ACTIVE        | SOIC         | DW                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AHCT540                              | Samples |
| SN74AHCT540N     | ACTIVE        | PDIP         | N                  | 20   | 20             | RoHS &<br>Non-Green | NIPDAU                        | N / A for Pkg Type   | -40 to 125   | SN74AHCT540N                         | Samples |
| SN74AHCT540NSR   | ACTIVE        | SO           | NS                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | AHCT540                              | Samples |
| SN74AHCT540PW    | ACTIVE        | TSSOP        | PW                 | 20   | 70             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | HB540                                | Samples |
| SN74AHCT540PWR   | ACTIVE        | TSSOP        | PW                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 125   | HB540                                | Samples |
| SNJ54AHCT540J    | ACTIVE        | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type   | -55 to 125   | 5962-9685101QR<br>A<br>SNJ54AHCT540J | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.



# PACKAGE OPTION ADDENDUM

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54AHCT540, SN74AHCT540 :

• Catalog : SN74AHCT540

• Military : SN54AHCT540

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

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#### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

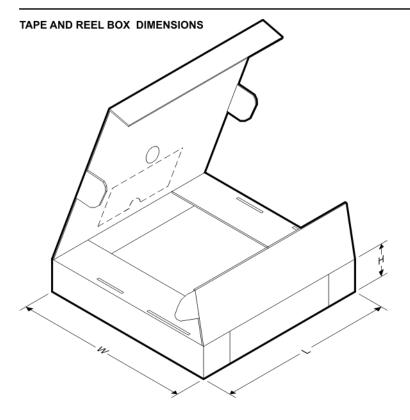


| Device          | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AHCT540DBR  | SSOP            | DB                 | 20 | 2000 | 330.0                    | 16.4                     | 8.2        | 7.5        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74AHCT540DGVR | TVSOP           | DGV                | 20 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74AHCT540DWR  | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| SN74AHCT540NSR  | SO              | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.4        | 13.0       | 2.5        | 12.0       | 24.0      | Q1               |
| SN74AHCT540PWR  | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.1        | 1.6        | 8.0        | 16.0      | Q1               |



# PACKAGE MATERIALS INFORMATION

16-Feb-2022



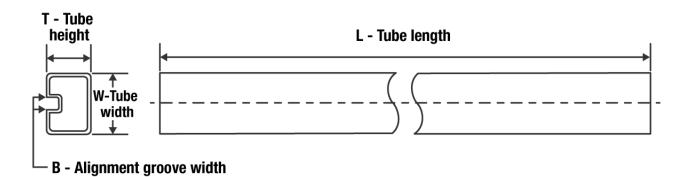
\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AHCT540DBR  | SSOP         | DB              | 20   | 2000 | 853.0       | 449.0      | 35.0        |
| SN74AHCT540DGVR | TVSOP        | DGV             | 20   | 2000 | 853.0       | 449.0      | 35.0        |
| SN74AHCT540DWR  | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74AHCT540NSR  | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74AHCT540PWR  | TSSOP        | PW              | 20   | 2000 | 853.0       | 449.0      | 35.0        |



16-Feb-2022

#### TUBE



#### \*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74AHCT540DW | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74AHCT540N  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74AHCT540PW | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |

# **PW0020A**



# **PACKAGE OUTLINE**

# TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



# PW0020A

# **EXAMPLE BOARD LAYOUT**

### TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# PW0020A

# **EXAMPLE STENCIL DESIGN**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



# LAND PATTERN DATA



NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
  C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# **DB0020A**



# **PACKAGE OUTLINE**

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-150.



# DB0020A

# **EXAMPLE BOARD LAYOUT**

# SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DB0020A

# **EXAMPLE STENCIL DESIGN**

# SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# **MECHANICAL DATA**

PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

#### DGV (R-PDSO-G\*\*)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



# **DW0020A**



# **PACKAGE OUTLINE**

### SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



# DW0020A

# **EXAMPLE BOARD LAYOUT**

### SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DW0020A

# **EXAMPLE STENCIL DESIGN**

### SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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